

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6991247

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CYIENT LIMITED	02/26/2021
RECEIVING PARTY DATA	
Name:	MEDTRONIC ENGINEERING AND INNOVATION CENTER PRIVATE LIMITED
Street Address:	DLF CYBER CITY, BLOCK NO. 3
Internal Address:	GROUND FLOOR, PLOT NO. 129 TO 132
City:	APHB COLONY, GACHIBOWLI, HYDERABAD
State/Country:	INDIA
Postal Code:	500019
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17103054
CORRESPONDENCE DATA	
Fax Number:	(203)495-5785
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2034925000
Email:	rs.patents.two@medtronic.com
Correspondent Name:	COVIDIEN LP
Address Line 1:	60 MIDDLETOWN AVENUE
Address Line 2:	MAILSTOP 54, LEGAL DEPT
Address Line 4:	NORTH HAVEN, CONNECTICUT 06473
ATTORNEY DOCKET NUMBER:	A0004259US01
NAME OF SUBMITTER:	CAROLYNN KNIGHT
SIGNATURE:	/Carolynn KNIGHT/
DATE SIGNED:	10/27/2021
Total Attachments: 4	
source=1A0004259US01 Assignment - Cyient to MEIC - Fully Executed#page1.tif	
source=1A0004259US01 Assignment - Cyient to MEIC - Fully Executed#page2.tif	
source=1A0004259US01 Assignment - Cyient to MEIC - Fully Executed#page3.tif	

DEED OF ASSIGNMENT

This Deed of Assignment is executed by:

CYIENT LIMITED, having its registered office at Plot 11, Software Units Layout, Infocity, Madhapur, Hyderabad, Telangana, 500081, India, and its representatives and affiliates (hereinafter referred to as "Assignor");

and, MEDTRONIC ENGINEERING AND INNOVATION CENTER PRIVATE LIMITED, having offices at DLF Cybercity, Block No. 3, Ground Floor, Plot No. 129 to 132 APHB Colony, Gachibowli, Hyderabad – 500019, Andhra Pradesh, India (hereinafter referred to as "Assignee").

WHEREAS, Assignor and Assignee entered into a Master Services Agreement dated August 1, 2019;

WHEREAS the Master Services Agreement transferred and assigned, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, all right, title and interest in any and all intellectual property, trade secrets and knowledge, including but not limited to methods, ideas, apparatuses, compositions, drawings, abstracts, specifications, inventions, written material, audiovisual material, formulas, data, computer software and rights related thereto, including but not limited to copyrights, trademarks, patents, patent applications, trade secrets, and other properties developed by Assignor or Assignee under the Master Services Agreement either jointly or individually ("Intellectual Property");

WHEREAS, Assignor hereby acknowledges, by virtue of the Master Services Agreement, Assignor transferred to Assignee all right, title and interest in and to the inventions and applications (including any continuations, continuations-in-part, divisionals, RCE's or other parent or child applications or inventions) and to all foreign counterparts thereof (including patent, utility model and industrial designs), as listed on the attached *Schedule A*, and in and to any Letters Patent and Registrations which may hereafter be granted on any patent applications claiming priority from the same in the United States and all countries throughout the world, and to claim the priority from the applications as provided by the Paris Convention. The right, title and interest is to be held and enjoyed by Assignee and Assignee's successors and assigns as fully and exclusively as it would have been held and enjoyed by Assignor had this Deed of Assignment not been made, for the full term of any Letters Patent and Registrations which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof;

WHEREAS Assignor desires to ensure to that to the extent any of Assignor's right, title and interest in the foregoing Intellectual Property, including the patents and applications listed on the attached *Schedule A*, are deemed not transferred from Assignor to Assignee, that any such past, present and future rights, title and interest in the foregoing Intellectual Property be presently assigned to Assignee.

[CONTINUED ON NEXT PAGE]

NOW, THEREFORE, the parties agree as follows:

ASSIGNOR: CYIENT LIMITED

Hereby sells, assigns and transfers to

ASSIGNEE: MEDTRONIC ENGINEERING AND INNOVATION CENTER PRIVATE LIMITED

And the successors, assigns and legal representatives of the ASSIGNEE any and all rights, title and interest ASSIGNOR may have, if any, including the right to sue for present, past and future infringement, in the United States, its territorial possessions, and in all foreign countries, including all treaty and convention rights, the Intellectual Property, including the inventions and applications (including any continuations, continuations-in-part, divisionals, RCE's or other parent or child applications or inventions) and to all foreign counterparts thereof (including patent, utility model and industrial designs), as listed on the attached *Schedule A*, and in and to any Letters Patent and Registrations which may hereafter be granted on any patent applications claiming priority from the same in the United States and all countries throughout the world, and to claim the priority from the applications as provided by the Paris Convention.

[THE REST OF THIS PAGE LEFT INTENTIONALLY BLANK]

IN TESTIMONY WHEREOF, Assignor has signed his name on the date indicated.

CYIENT LIMITED

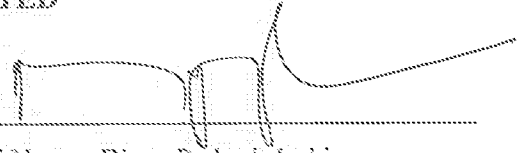


Printed Name: S V Pavan Kumar

Title: Deputy General Manager

Dated: 26 - Feb - 2021

**MEDTRONIC ENGINEERING AND
INNOVATION CENTER PRIVATE
LIMITED**



Printed Name: Divya Prakash Joshi

Title: Sr. Engineering Director

Dated: 16-Mar-2021

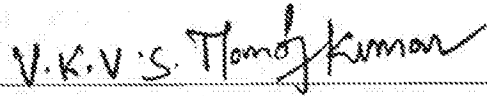
WITNESS



Printed Name: Prasad Kandula

Dated: 26 - Feb - 2021

WITNESS



Printed Name: K V S Manoj Kumar Vadali

Dated: 16-Mar-2021

